# NSR01L30MX

# **Schottky Barrier Diode**

These Schottky barrier diodes are optimized for low forward voltage drop and low leakage current.

#### **Features**

- Very Low Forward Voltage Drop 350 mV @ 1 mA
- Low Reverse Current 0.2 μA @ 10 V
- 100 mA of Continuous Forward Current
- ESD Rating Human Body Model: Class 3B
  - Machine Model: Class C
- This is a Halide-Free Device
- This is a Pb-Free Device

#### **Typical Applications**

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost dc-dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

#### **Markets**

- Mobile Handsets
- MP3 Players
- Digital Camera and Camcorders
- Notebook PCs & PDAs
- GPS

#### **MAXIMUM RATINGS**

Rating		Symbol	Value	Unit
Reverse Voltage		V <sub>R</sub>	30	V
Forward Current (DC)		IF	100	mA
Forward Surge Current (60 Hz @ 1 cycle)		I <sub>FSM</sub>	2.0	А
ESD Rating:	Human Body Model Machine Model	ESD	>8.0 >400	kV V

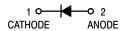
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



#### ON Semiconductor®

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# 30 V SCHOTTKY BARRIER DIODE





X3DFN2 CASE 152AF MARKING DIAGRAM

PIN 1

= Specific Device Code (Rotated 180°) M = Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping†
NSR01L30MXT5G	X3DFN2 (Pb-Free)	10000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## NSR01L30MX

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Min	Тур	Max	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T <sub>A</sub> = 25°C	R <sub>θJA</sub> P <sub>D</sub>			695 180	°C/W mW
Storage Temperature Range	T <sub>stg</sub>			-55 to +150	°C
Junction Temperature	TJ			+150	°C

<sup>1.</sup> Mounted onto a 4 in square FR-4 board 100 mm sq. 2 oz. Cu 0.06" thick single-sided. Operating to steady state.

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage $(V_R = 10 \text{ V})$ $(V_R = 30 \text{ V})$	I <sub>R</sub>			0.2 0.5	μΑ
Forward Voltage (I <sub>F</sub> = 1 mA) (I <sub>F</sub> = 10 mA)	V <sub>F</sub>			0.35 0.46	V
Total Capacitance (V <sub>R</sub> = 5.0 V, f = 1 MHz)	СТ		0.8		pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# NSR01L30MX

## **TYPICAL CHARACTERISTICS**

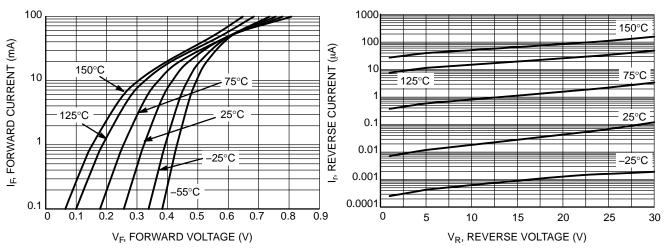


Figure 1. Forward Voltage

Figure 2. Leakage Current

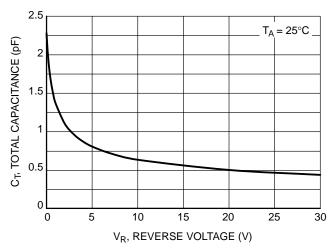
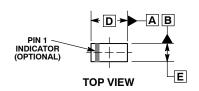


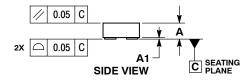
Figure 3. Total Capacitance

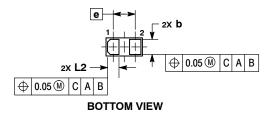


#### X3DFN2, 0.62x0.32, 0.355P, (0201) CASE 152AF **ISSUE A**

**DATE 17 FEB 2015** 







#### NOTES:

- ANTES.

  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.

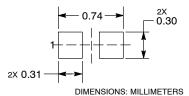
	MILLIMETERS			
DIM	MIN	MAX		
Α	0.25	0.33		
A1	-	0.05		
b	0.22	0.28		
D	0.58	0.66		
E	0.28	0.36		
е	0.355 BSC			
L2	0.17	0.23		

#### **GENERIC MARKING DIAGRAM\***



X = Specific Device Code M = Date Code

#### **RECOMMENDED MOUNTING FOOTPRINT\***



See Application Note AND8398/D for more mounting details

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	X3DFN2, 0.62X0.32, 0.355P, (0201)		PAGE 1 OF 1		

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